

1. PART NO. EXPRESSION :

SCI0805HQ-2N5JF

(a) (b) (c) (d) (e)(f)

(a) Series code

(b) Dimension code

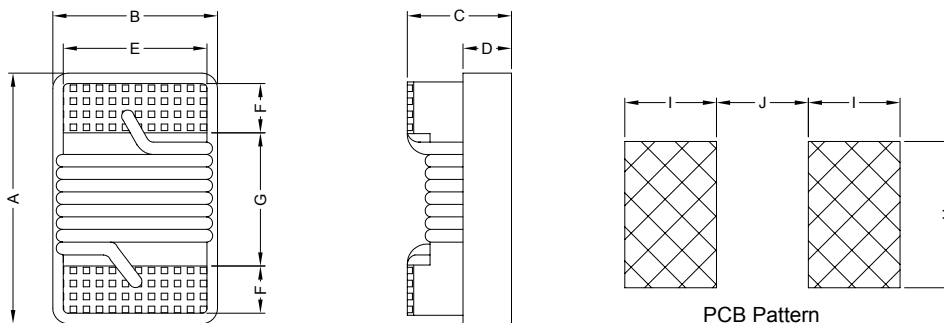
(c) Type code : HQ (High Q factor)

(d) Inductance code : 2N5 = 2.5nH

(e) Tolerance code : G = ±2%, J = ±5%, K = ±10%

(f) F : Lead Free

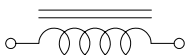
2. CONFIGURATION & DIMENSIONS :



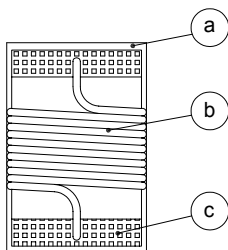
Unit:m/m

A	B	C	D	E	F	G	H	I	J
2.29 Max.	1.73 Max.	1.52 Max.	0.51 Ref.	1.27 Ref.	0.44 Ref.	1.02 Ref.	1.78 Ref.	1.02 Ref.	0.76 Ref.

3. SCHEMATIC :



4. MATERIALS :



(a) Core : Ceramic U core

(b) Wire : Enamelled Copper Wire

(c) Terminal Metallization : Ag + Ni + Au



RoHS Compliant

NOTE : Specifications subject to change without notice. Please check our website for latest information.

15.01.2008



SUPERWORLD ELECTRONICS (S) PTE LTD

5. GENERAL SPECIFICATION :

- a) Storage temp. : -25°C to +80°C
- b) Operating temp. : -40°C to +125°C
- c) Temperature rise : 40°C Max.
- d) Rated current : Base on temp. rise & $\Delta L/L0A=10\%$ Max.
- e) Resistance to solder heat : 260°C.10sec

6. ELECTRICAL CHARACTERISTICS :

Part No.	Tolerance Available	L (nH)	Test Freq (MHz)	Q Min.	Q Test Freq (MHz)	SRF (MHz) Min.	DCR (Ω) Max.	IDC (mA) Max.
SCI0805HQ-2N5□F	K, J	2.5	250	80	1500	6000	0.020	1600
SCI0805HQ-5N6□F	K, J	5.6	250	98	1500	6000	0.035	1600
SCI0805HQ-6N2□F	K, J	6.2	250	88	1000	4750	0.035	1600
SCI0805HQ-6N8□F	K, J	6.8	250	80	1000	4400	0.035	1600
SCI0805HQ-8N2□F	K, J	8.2	250	75	1000	3000	0.075	1000
SCI0805HQ-12N□F	K, J	12	250	80	1000	3000	0.045	1600
SCI0805HQ-16N□F	K, J, G	16	250	72	500	2950	0.060	1500
SCI0805HQ-18N□F	K, J, G	18	250	75	500	2550	0.060	1400
SCI0805HQ-20N□F	K, J, G	20	250	70	500	2050	0.055	1400
SCI0805HQ-27N□F	K, J, G	27	250	75	500	2000	0.070	1300
SCI0805HQ-30N□F	K, J, G	30	250	65	500	1950	0.095	1200
SCI0805HQ-39N□F	K, J, G	39	250	65	500	1600	0.110	1100
SCI0805HQ-48N□F	K, J, G	48	200	65	500	1400	0.095	1200
SCI0805HQ-51N□F	K, J, G	51	200	65	500	1400	0.120	1000

Inductance tolerance :

- : G : $\pm 2\%$
- J : $\pm 5\%$
- K : $\pm 10\%$



RoHS Compliant

NOTE : Specifications subject to change without notice. Please check our website for latest information.

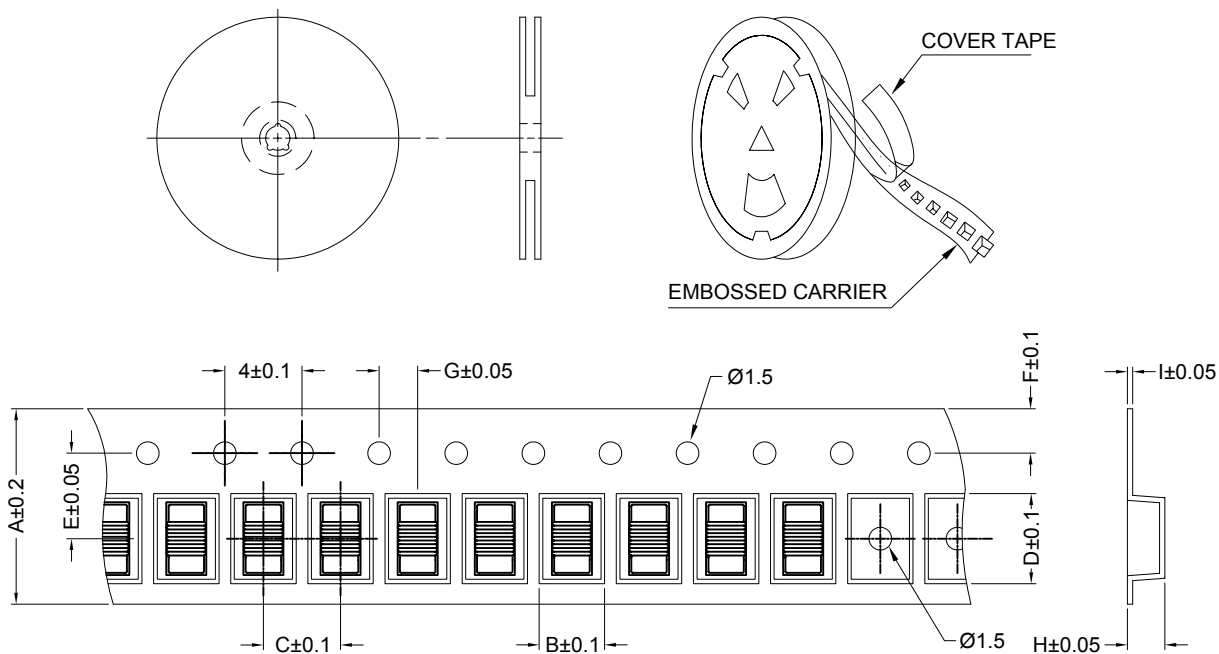
15.01.2008



SUPERWORLD ELECTRONICS (S) PTE LTD

7. ELECTRICAL CHARACTERISTICS :

CONFIGURATTION :



DIMENSION (unit: mm)

SERIES	A	B	C	D	E	F	G	H	I
SCI0402	8.0	0.71	2.0	1.16	3.5	1.75	0	0.65	0.23
SCI0603	8.0	1.10	4.0	1.75	3.5	1.75	2	1.15	0.25
SCI0805	8.0	1.88	4.0	2.38	3.5	1.75	2	1.48	0.20
SCI1008	8.0	2.73	4.0	2.88	3.5	1.75	2	2.33	0.20

PACKING QUANTITY

SERIES	INNER REEL
	Q'TY (PCS)
SCI0402	4000
SCI0603	4000
SCI0805	2000
SCI1008	2000



RoHS Compliant

NOTE : Specifications subject to change without notice. Please check our website for latest information.

15.01.2008



SUPERWORLD ELECTRONICS (S) PTE LTD

8. ENVIRONMENTAL CHARACTERISTICS :

Electrical Performance Test :

ITEM		SPECIFICATION	TEST CONDITIONS / TEST METHODS
1	Inductance	Refer to Electrical Characteristics List	HP4291B
2	Q		HP4291B
3	SRF		HP8753D
4	DC Resistance Rdc		Mico-Ohmmeter (GOM-801G)
5	Rated Current IDC		The device should be REFLOW soldered (230±5°C for 10 seconds) to a tinned copper subs rate. A dynamiter
6	Over Load Test	After test, inductors shall have no evidence of electrical and mechanical damage	Applied 2 times of rated allowed DC current to inductor for a period of 5 minute.
7	Withstanding Voltage Test	After test, inductors shall have no evidence of electrical and mechanical damage	AC voltage of 500VAC applied between inductors terminal and case for 1 minute.
8	Insulation Resistance Test	1000 MOhm min.	100VDC applied between inductor terminal and case



RoHS Compliant

NOTE : Specifications subject to change without notice. Please check our website for latest information.

15.01.2008



SUPERWORLD ELECTRONICS (S) PTE LTD

Mechanical Performance Test :

ITEM		SPECIFICATION	TEST CONDITIONS / TEST METHODS
1	Vibration	Appearance : No damage L change : within $\pm 5\%$ Q change : within $\pm 10\%$	Test device shall be soldered on the substrate Oscillation Frequency : 10 to 55 to 10Hz for 1 min. Amplitude : 1.5mm Time : 2hrs for each axis (X, Y, Z), total 6hrs.
2	Resistance to Soldering Heat	Appearance : No damage L change : within $\pm 5\%$ Q change : within $\pm 10\%$	Pre-heating : 150°C, 1 min Solder Composition : Sn/Pb=63/67 Solder Temperature : 230 \pm 5°C Immersion Time : 20 \pm 2sec Solder Temperature : 260 \pm 5°C Immersion Time : 5 \pm 2sec
3	Component Adhesion (Push Test)	1 lbs. For 0402 2 lbs. For 0603 3 lbs. For the rest	The device should be REFLOW soldered (230 \pm 5°C for 10 seconds) to a tinned copper subs rate. A dynamiter force gauge should be applied to the side of the component. The device must withstand a minimum force of 2 or 4 pounds without a failure of the termination attached to component.
3	Component Adhesion (Push Test)	The electrodes shall be at least 90% covered with new solder coating.	Pre-heating : 150°C, 1min Solder Composition : Sn/Pb=63/67 Solder Temperature : 230 \pm 5°C Immersion Time : 4 \pm 1sec
4	Drop Test	After test, the chip inductor don't fell of broke on the P.C.Board	Drop 1 time for each face and 1 time for each corner. Total drop 10 times. Drop Height : 100cm Drop Weight : 125g
5	Solderability Test	The terminal should at least be 90% covered with solder	after fluxing (alpha 100 or equiv), inductor shall be dipped in a melted solder bath at 232 \pm 5°C for 5 seconds.
6	Resistance to solvent test	There shall be no case of deformation change in appearance of obliteration of marking	MIL-STD202F, METHOD 215D



RoHS Compliant

NOTE : Specifications subject to change without notice. Please check our website for latest information.

15.01.2008



SUPERWORLD ELECTRONICS (S) PTE LTD

Climatic Test :

ITEM		SPECIFICATION	TEST CONDITIONS / TEST METHODS															
1	Temperature Characteristics	Appearance : No damage L change : within $\pm 10\%$ Q change : within $\pm 20\%$	-40°C ~ +125°C															
2	Humidity Resistance		Temperature : 40 \pm 2°C Relative Humidity : 90~95% Time : 96hrs \pm 2hrs Measured after exposure in the room condition for 2hrs															
3	Low Temperature Storage Test		Temperature : -40 \pm 2°C Time : 48 \pm 2hrs Inductors are to be tested after 1 hour at room temperature.															
4	Thermal Shock Test		One cycle : <table border="1" style="margin-left: 20px;"> <thead> <tr> <th>Step</th> <th>Temperature (°C)</th> <th>Time (min)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>-25\pm3</td> <td>30</td> </tr> <tr> <td>2</td> <td>25\pm2</td> <td>15</td> </tr> <tr> <td>3</td> <td>85\pm3</td> <td>30</td> </tr> <tr> <td>4</td> <td>25\pm2</td> <td>15</td> </tr> </tbody> </table> Total : 5 cycles	Step	Temperature (°C)	Time (min)	1	-25 \pm 3	30	2	25 \pm 2	15	3	85 \pm 3	30	4	25 \pm 2	15
Step	Temperature (°C)		Time (min)															
1	-25 \pm 3		30															
2	25 \pm 2		15															
3	85 \pm 3	30																
4	25 \pm 2	15																
5	High Temperature Storage Test	Temperature : 125 \pm 2°C Time : 48 \pm 2hrs Load : Allowed DC current																
6	High Temperature Load Life Test	Temperature : 85 \pm 2°C Time : 1000 \pm 12hrs Load : Allowed DC current																
7	Humidity Load Life	Temperature : 40 \pm 2°C Relative Humidity : 90~95% Time : 1000 \pm 12hrs Load : Allowed DC current																



RoHS Compliant

NOTE : Specifications subject to change without notice. Please check our website for latest information.

15.01.2008



SUPERWORLD ELECTRONICS (S) PTE LTD